	FORM COVER SHEET U.S. DEPARTMENT OF COMMEN
OMB No. 0651-0027 (exp. 6/30/2005)	U.S. Patent and Trademark Of 2003 P 50524
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To the honorable Commissioner of Patents and Tradem	arks: Please record the attached original documents or copy thereof.
1. Name of conveying party(ies): Jens Staecker Uwe Bruch Heiko Hommen	2. Name and address of receiving party(ies) Name: Infineon Technologies AG Internal Address:
Additional name(s) of conveying party(ies) attached?	No.
3. Nature of conveyance:	
X Assignment Merger	
Security Agreement Change of Name	Street Address: <u>StMartin-Strasse 53</u>
Other	City: <u>Muenchen</u> State: <u>Germany</u> Zip: <u>81</u> 669
	Additional name(s) & address(es) attached?
If this document is being filed together with a new application A. Patent Application No.(s) 10/802,618 Additional numbe 5. Name and address of party to whom correspondence concerning document should be mailed: Name: Ira S. Matsil Stater & Matsil, L.L.P. Internal Address: Street Address: 17950 Preston Rd.	a. the execution date of the application is: April 21, 2004 B. Patent No.(s) rs attached? Yes X 6. Total number of applications and patents involved: 1 7. Total fee (37 CFR 3.41). 40.00 Enclosed X X Authorized to be charged to deposit account
	8. Deposit account number:
<u>Suite 1000</u> City: <u>Dallas</u> State: <u>Texas</u> Zip: <u>75252-5793</u>	50-1065 (Attach duplicate copy of this page if paying by deposit account)
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Ira S. Matsil, Reg. No. 35,272 Name of Person Signing Total number of pages including cover sh	
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ASSIGNMENT

For good and valuable consideration, I, Jens Staecker, residing at Hauptstrasse 13, Dresden, Germany, 01097, a citizen of Germany; Uwe Bruch residing at Zur Neuen Bruccke 6, Dresden, Germany, 01109, a citizen of Germany; and Heiko Hommen, residing at Boehmische Strasse 15, Dresden, Germany, 01099, a citizen of Germany

hereby sell, assign, and transfer to Infineon Technologies AG, a corporation organized and existing under the laws of Germany, having its principal place of business at St.-Martin-Strasse 53, Muenchen, 81669, Germany;

hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewithin, and is entitled:

Arrangement for Transferring Information/Structures to Wafers

and in and to said application and all divisional, continuing substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that Assignee may apply for and receive Letters Patent for said improvements in its own name, and that, when requested, without charge to but at the expense of said Assignee, their successors, assigns, and legal representatives to carry out in good faith the intent and purpose of this agreement, the undersigned will execute all divisional, continuing substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, Page 1 of 2

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assigns, or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

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Uwe Bruch

Heiko Hemmen

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RECORDED: 06/28/2004